Preferred Device

# **Dual Switching Diode Common Cathode**

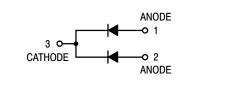
#### Features

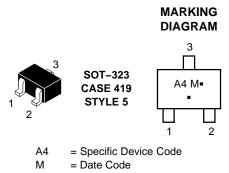
• Pb–Free Package is Available



### **ON Semiconductor®**

http://onsemi.com





= Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
BAV70WT1	SOT-323	3000/Tape & Reel
BAV70WT1G	SOT-323 (Pb-Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

### **MAXIMUM RATINGS** (T<sub>A</sub> = $25^{\circ}C$ )

Rating	Symbol	Мах	Unit
Reverse Voltage	V <sub>R</sub>	70	V
Forward Current	١ <sub>F</sub>	200	mA
Peak Forward Surge Current	I <sub>FM(surge)</sub>	500	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1) $T_A = 25^{\circ}C$	P <sub>D</sub>	200	mW
Derate above 25°C		1.6	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	625	°C/W
Total Device Dissipation Alumina Substrate (Note 2) $T_A = 25^{\circ}C$	P <sub>D</sub>	300	mW
Derate above 25°C		2.4	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

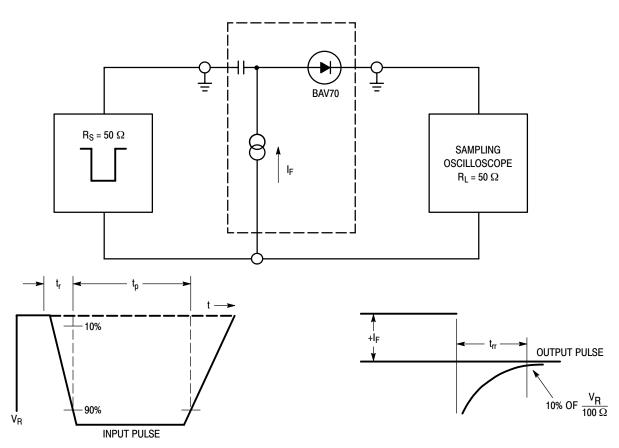
1. FR-5 = 1.0  $\times$  0.75  $\times$  0.062 in.

2. Alumina = 0.4  $\times$  0.3  $\times$  0.024 in. 99.5% alumina.

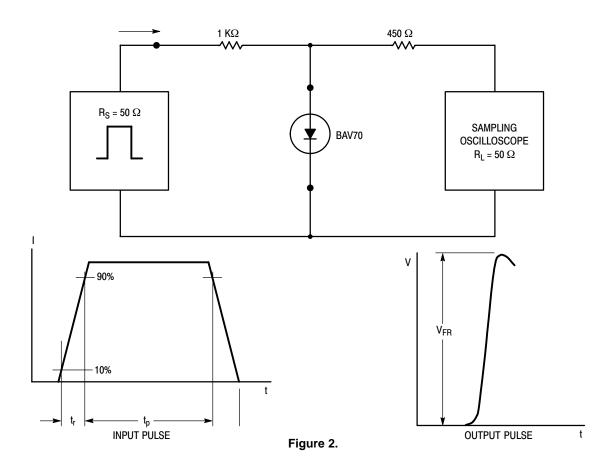
## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
Reverse Breakdown Voltage $(I_{(BR)} = 100 \ \mu A)$	V <sub>(BR)</sub>	70	-	V
Reverse Voltage Leakage Current (Note 3) $(V_R = 70 \text{ V})$ $(V_R = 50 \text{ V})$	I <sub>R</sub>		5.0 100	μA nA
Forward Voltage $(I_F = 1.0 \text{ mA})$ $(I_F = 10 \text{ mA})$ $(I_F = 50 \text{ mA})$ $(I_F = 150 \text{ mA})$	VF	- - -	715 855 1000 1250	mV
Diode Capacitance ( $V_R = 0 V$ , f = 1.0 MHz)	CD	-	1.5	pF
Reverse Recovery Time ( $I_F = I_R = 10 \text{ mA}, R_L = 100 \Omega, I_{R(REC)} = 1.0 \text{ mA}$ ) (Figure 1)	t <sub>rr</sub>	-	6.0	ns
Forward Recovery Voltage (I <sub>F</sub> = 10 mA, t <sub>r</sub> = 20 ns) (Figure 2)	V <sub>RF</sub>	-	1.75	V

3. For each individual diode while the second diode is unbiased.







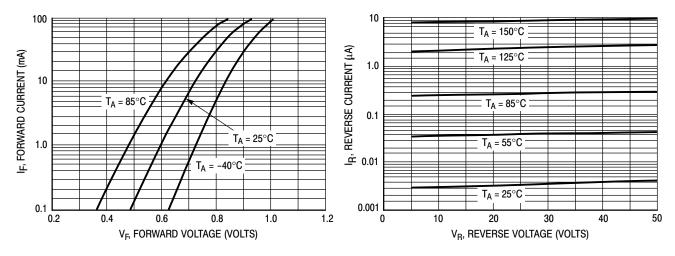


Figure 3. Forward Voltage

Figure 4. Leakage Current

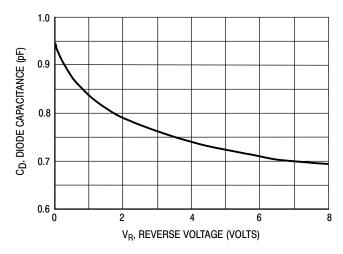
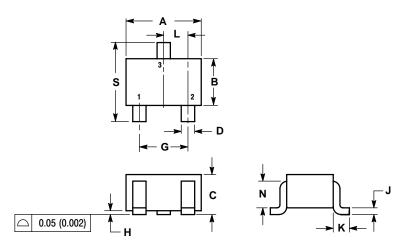


Figure 5. Capacitance

#### PACKAGE DIMENSIONS

SOT-323 (SC-70) CASE 419-04 ISSUE L



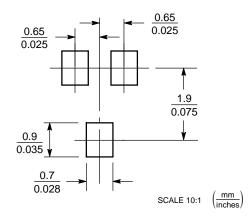
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
С	0.032	0.040	0.80	1.00
D	0.012	0.016	0.30	0.40
G	0.047	0.055	1.20	1.40
Н	0.000	0.004	0.00	0.10
J	0.004	0.010	0.10	0.25
Κ	0.017 REF		0.425 REF	
L	0.026 BSC		0.650 BSC	
Ν	0.028 REF		0.700 REF	
S	0.079	0.095	2.00	2.40

STYLE 5: PIN 1. ANODE 2. ANODE 3. CATHODE

**SOLDERING FOOTPRINT\*** 



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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